

2Mx8 LOW VOLTAGE, ULTRA LOW POWER CMOS STATIC RAM

FEATURES

- High-speed access time: 45ns, 55ns
- CMOS low power operation
 - 30 mW (typical) operating
 - 12 μ W (typical) CMOS standby
- TTL compatible interface levels
- Single power supply
 - 1.65V–1.98V V_{DD} (62/65WV20488EALL)
 - 2.2V–3.6V V_{DD} (62/65WV20488EBLL)
- Fully static operation: no clock or refresh required
- Industrial (-40°C to +85°C) and Automotive (-40°C to +125°C) temperature support

DESCRIPTION

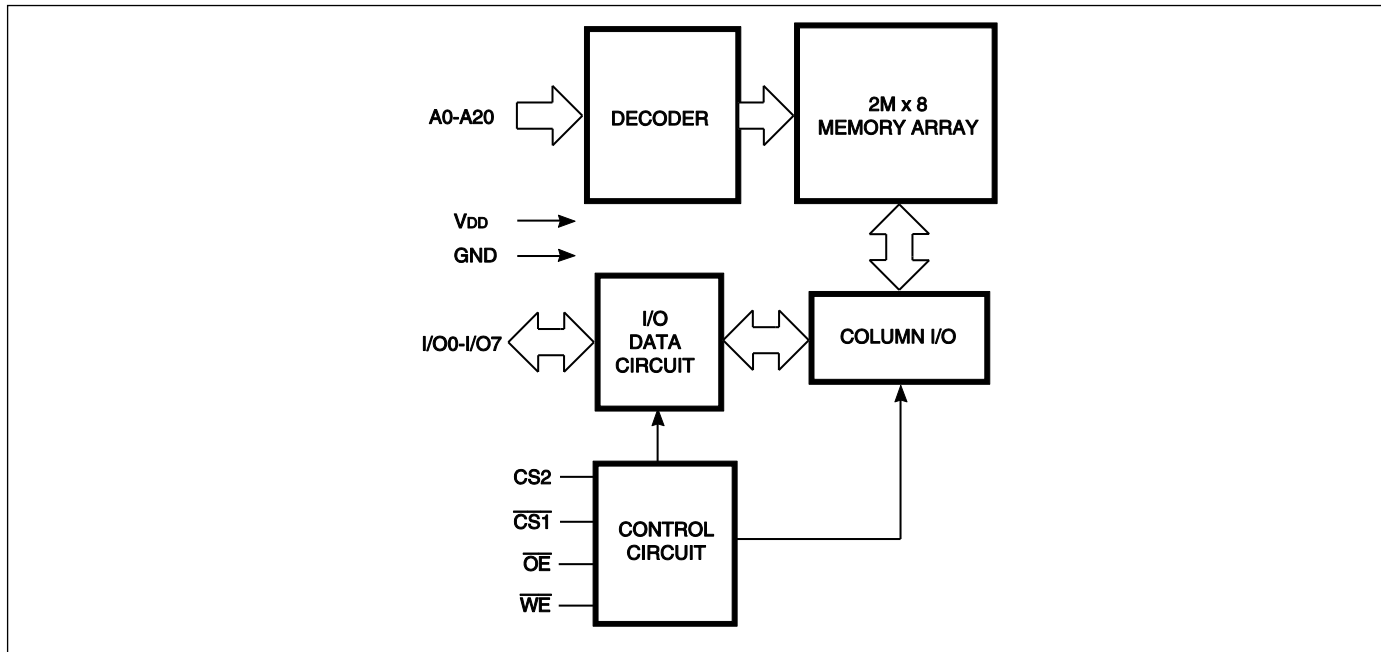
The ISSI IS62WV20488EALL/BLL and IS65WV20488EALL/BLL are high-speed, 16M bit static RAMs organized as 2M words by 8 bits. It is fabricated using ISSI's high-performance CMOS technology. This highly reliable process coupled with innovative circuit design techniques, yields high-performance and low power consumption devices.

When $\overline{CS1}$ is HIGH (deselected) or when CS2 is LOW (deselected), the device assumes a standby mode at which the power dissipation can be reduced down with CMOS input levels.

Easy memory expansion is provided by using Chip Enable and Output Enable inputs. The active LOW Write Enable (\overline{WE}) controls both writing and reading of the memory.

The IS62WV20488EALL/BLL and IS65WV20488EALL/BLL are packaged in the JEDEC standard 48-pin mini BGA (6mm x 8mm).

BLOCK DIAGRAM



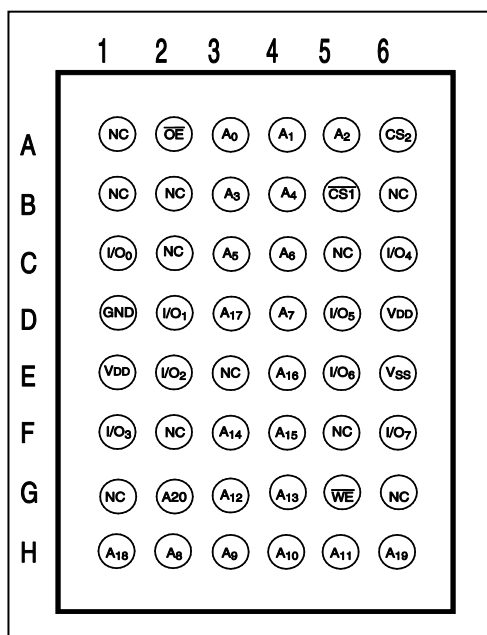
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- a.) the risk of injury or damage has been minimized;
- b.) the user assume all such risks; and
- c.) potential liability of Integrated Silicon Solution, Inc is adequately protected under the circumstances

PIN CONFIGURATION (2M x 8 Low Power)

48-pin mini BGA (B) (6mm x 8mm)



PIN DESCRIPTIONS

A0-A20	Address Inputs
$\overline{CS1}$	Chip Enable 1 Input
CS2	Chip Enable 2 Input
\overline{OE}	Output Enable Input
\overline{WE}	Write Enable Input
I/O0-I/O7	Input/Output
NC	No Connection
VDD	Power
GND	Ground

TRUTH TABLE

Mode	\overline{WE}	$\overline{CS1}$	CS2	\overline{OE}	I/O Operation	VDD Current
Not Selected	X	H	X	X	High-Z	ISB1, ISB2
(Power-down)	X	X	L	X	High-Z	ISB1, ISB2
Output Disabled	H	L	H	H	High-Z	I _{cc}
Read	H	L	H	L	Dout	I _{cc}
Write	L	L	H	X	Din	I _{cc}

OPERATING RANGE (VDD)

Range	Ambient Temperature	1.65V – 1.98V	2.2V - 3.6V
Commercial	0°C to +70°C	IS62WV20488EALL (55ns)	IS62WV20488EBLL (45, 55ns)
Industrial	-40°C to +85°C	IS62WV20488EALL (55ns)	IS62WV20488EBLL (45, 55ns)
Automotive	-40°C to +125°C	IS65WV20488EALL (55ns)	IS65WV20488EBLL (55ns)

ABSOLUTE MAXIMUM RATINGS AND OPERATING RANGE

ABSOLUTE MAXIMUM RATINGS⁽¹⁾

Symbol	Parameter	Value	Unit
V _{term}	Terminal Voltage with Respect to GND	-0.2 to +3.9(V _{DD} +0.3V)	V
t _{BIAS}	Temperature Under Bias	-55 to +125	°C
V _{DD}	V _{DD} Related to GND	-0.2 to +3.9(V _{DD} +0.3V)	V
t _{Stg}	Storage Temperature	-65 to +150	°C
I _{OUT}	DC Output Current (LOW)	20	mA

Notes:

1. Stress greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

OPERATING RANGE⁽¹⁾

Range	Device Marking	Ambient Temperature	V _{DD} (min)	V _{DD} (typ)	V _{DD} (max)
Commercial	IS62WV20488EALL	0°C to +70°C	1.65V	1.8V	1.98V
Industrial	IS62WV20488EALL	-40°C to +85°C	1.65V	1.8V	1.98V
Automotive	IS65WV20488EALL	-40°C to +125°C	1.65V	1.8V	1.98V
Commercial	IS62WV20488EBLL	0°C to +70°C	2.2V	3.3V	3.6V
Industrial	IS62WV20488EBLL	-40°C to +85°C	2.2V	3.3V	3.6V
Automotive	IS65WV20488EBLL	-40°C to +125°C	2.2V	3.3V	3.6V

Note:

1. Full device AC operation assumes a 100 μs ramp time from 0 to V_{cc}(min) and 200 μs wait time after V_{cc} stabilization.

PIN CAPACITANCE⁽¹⁾

Parameter	Symbol	Test Condition	Max	Units
Input capacitance	C _{IN}	T _A = 25°C, f = 1 MHz, V _{DD} = V _{DD} (typ)	10	pF
DQ capacitance (IO0–IO7)	C _{I/O}		10	pF

Note:

1. These parameters are guaranteed by design and tested by a sample basis only.

THERMAL CHARACTERISTICS⁽¹⁾

Parameter	Symbol	Rating	Units
Thermal resistance from junction to ambient (airflow = 1m/s)	R _{θJA}	38.3	°C/W
Thermal resistance from junction to case	R _{θJC}	6.86	°C/W

Note:

1. These parameters are guaranteed by design and tested by a sample basis only.

ELECTRICAL CHARACTERISTICS

IS62(5)WV20488EALL DC ELECTRICAL CHARACTERISTICS-I (OVER THE OPERATING RANGE)

Symbol	Parameter	Test Conditions	Min.	Max.	Unit
V_{OH}	Output HIGH Voltage	$I_{OH} = -0.1 \text{ mA}$	1.4	—	V
V_{OL}	Output LOW Voltage	$I_{OL} = 0.1 \text{ mA}$	—	0.2	V
$V_{IH}^{(1)}$	Input HIGH Voltage		1.4	$V_{DD} + 0.2$	V
$V_{IL}^{(1)}$	Input LOW Voltage		-0.2	0.4	V
I_{LI}	Input Leakage	$GND < V_{IN} < V_{DD}$	-1	1	μA
I_{LO}	Output Leakage	$GND < V_{IN} < V_{DD}$, Output Disabled	-1	1	μA

Notes:

- $V_{ILL}(\text{min}) = -1.0\text{V AC}$ (pulse width < 10ns). Not 100% tested.
 $V_{IHH}(\text{max}) = V_{DD} + 1.0\text{V AC}$ (pulse width < 10ns). Not 100% tested.

IS62(5)WV20488EBLL DC ELECTRICAL CHARACTERISTICS-I (OVER THE OPERATING RANGE)

Symbol	Parameter	Test Conditions	Min.	Max.	Unit
V_{OH}	Output HIGH Voltage	$2.2 \leq V_{DD} < 2.7$, $I_{OH} = -0.1 \text{ mA}$	2.0	—	V
		$2.7 \leq V_{DD} \leq 3.6$, $I_{OH} = -1.0 \text{ mA}$	2.4	—	V
V_{OL}	Output LOW Voltage	$2.2 \leq V_{DD} < 2.7$, $I_{OL} = 0.1 \text{ mA}$	—	0.4	V
		$2.7 \leq V_{DD} \leq 3.6$, $I_{OL} = 2.1 \text{ mA}$	—	0.4	V
$V_{IH}^{(1)}$	Input HIGH Voltage	$2.2 \leq V_{DD} < 2.7$	1.8	$V_{DD} + 0.3$	V
		$2.7 \leq V_{DD} \leq 3.6$	2.2	$V_{DD} + 0.3$	V
$V_{IL}^{(1)}$	Input LOW Voltage	$2.2 \leq V_{DD} < 2.7$	-0.3	0.6	V
		$2.7 \leq V_{DD} \leq 3.6$	-0.3	0.8	V
I_{LI}	Input Leakage	$GND < V_{IN} < V_{DD}$	-1	1	μA
I_{LO}	Output Leakage	$GND < V_{IN} < V_{DD}$, Output Disabled	-1	1	μA

Notes:

- $V_{ILL}(\text{min}) = -2.0\text{V AC}$ (pulse width < 10ns). Not 100% tested.
 $V_{IHH}(\text{max}) = V_{DD} + 2.0\text{V AC}$ (pulse width < 10ns). Not 100% tested.

**IS62(5)WV20488EALL DC ELECTRICAL CHARACTERISTICS-II FOR POWER
(OVER THE OPERATING RANGE)**

Symbol	Parameter	Test Conditions	Grade	Typ.	Max.	Unit
ICC	V _{DD} Dynamic Operating Supply Current	V _{DD} =V _{DD} (max), I _{OUT} =0mA, f=f _{MAX}	Com.	6	12	mA
			Ind.	-	12	
			Auto.	-	12	
ICC1	V _{DD} Static Operating Supply Current	V _{DD} =V _{DD} (max), I _{OUT} = 0mA, f=0Hz	Com.	3	6	mA
			Ind.	-	6	
			Auto.	-	6	
ISB1	CMOS Standby Current (CMOS Inputs)	V _{DD} =V _{DD} (max), (1) 0V ≤ CS2 ≤ 0.2V or (2) $\overline{CS1} \geq V_{DD} - 0.2V$, CS2 ≥ V _{DD} - 0.2V	Com.	30	50	μA
			Ind.	-	65	μA
			Auto.	-	165	μA

Note:

Typical values are included for reference only and are not guaranteed or tested. Typical values are measured at VDD = VDD(typ), TA = 25°C

**IS62(5)WV20488EBLL DC ELECTRICAL CHARACTERISTICS-II FOR POWER
(OVER THE OPERATING RANGE)**

Symbol	Parameter	Test Conditions	Grade	Typ.	Max.	Unit
ICC	V _{DD} Dynamic Operating Supply Current	V _{DD} =V _{DD} (max), I _{OUT} =0mA, f=f _{MAX}	Com.	6	12	mA
			Ind.	-	12	
			Auto.	-	12	
ICC1	V _{DD} Static Operating Supply Current	V _{DD} =V _{DD} (max), I _{OUT} = 0mA, f=0Hz	Com.	3	6	mA
			Ind.	-	6	
			Auto.	-	6	
ISB1	CMOS Standby Current (CMOS Inputs)	V _{DD} =V _{DD} (max), (1) 0V ≤ CS2 ≤ 0.2V or (2) $\overline{CS1} \geq V_{DD} - 0.2V$, CS2 ≥ V _{DD} - 0.2V	Com.	30	50	μA
			Ind.	-	65	μA
			Auto.	-	165	μA

Note:

Typical values are included for reference only and are not guaranteed or tested. Typical values are measured at VDD = VDD(typ), TA = 25°C

AC CHARACTERISTICS⁽⁶⁾ (OVER OPERATING RANGE)

READ CYCLE AC CHARACTERISTICS

Parameter	Symbol	45ns		55ns		unit	notes
		Min	Max	Min	Max		
Read Cycle Time	tRC	45	-	55	-	ns	1,5
Address Access Time	tAA	-	45	-	55	ns	1
Output Hold Time	tOHA	8	-	8	-	ns	1
$\overline{CS1}$, CS2 Access Time	tACS1/tACS2	-	45	-	55	ns	1
\overline{OE} Access Time	tDOE	-	22	-	25	ns	1
\overline{OE} to High-Z Output	tHZOE	-	18	-	18	ns	2
\overline{OE} to Low-Z Output	tLZOE	5	-	5	-	ns	2
$\overline{CS1}$, CS2 to High-Z Output	tHZCS//tHZCS2	-	18	-	18	ns	2
$\overline{CS1}$, CS2 to Low-Z Output	tLZCS/tLZCS2	10	-	10	-	ns	2

WRITE CYCLE AC CHARACTERISTICS

Parameter	Symbol	45ns		55ns		unit	notes
		Min	Max	Min	Max		
Write Cycle Time	tWC	45	-	55	-	ns	1,3,5
$\overline{CS1}$, CS2 to Write End	tSCS1/tSCS2	35	-	40	-	ns	1,3
Address Setup Time to Write End	tAW	35	-	40	-	ns	1,3
Address Hold from Write End	tHA	0	-	0	-	ns	1,3
Address Setup Time	tSA	0	-	0	-	ns	1,3
\overline{WE} Pulse Width	tPWE	35	-	40	-	ns	1,3,4
Data Setup to Write End	tSD	28	-	28	-	ns	1,3
Data Hold from Write End	tHD	0	-	0	-	ns	1,3
\overline{WE} LOW to High-Z Output	tHZWE	-	18	-	18	ns	2,3
\overline{WE} HIGH to Low-Z Output	tLZWE	10	-	10	-	ns	2,3

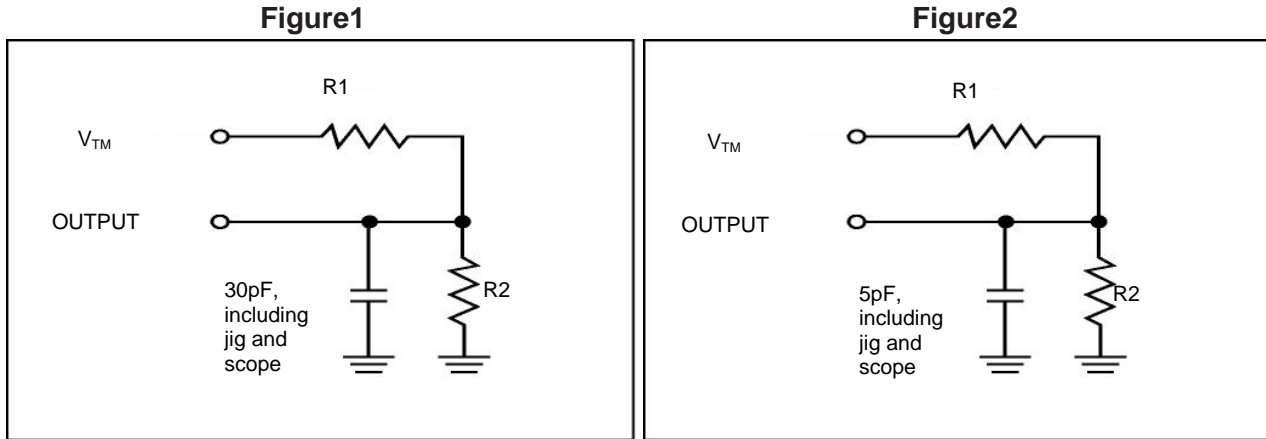
Notes:

1. Tested with the load in Figure 1.
2. Tested with the load in Figure 2. Transition is measured ± 500 mV from steady-state voltage. tHZOE, tHZCS, tHZB, and tHZWE transitions are measured when the output enters a high impedance state. Not 100% tested.
3. The internal write time is defined by the overlap of $\overline{CS1}$ =LOW, CS2=HIGH, (\overline{UB} or \overline{LB})=LOW, and \overline{WE} =LOW. All four conditions must be in valid states to initiate a Write, but any condition can go inactive to terminate the Write. The Data Input Setup and Hold timing are referenced to the rising or falling edge of the signal that terminates the write.
4. tPWE > tHZWE + tSD when OE is LOW.
5. Address inputs must meet V_{IH} and V_{IL} SPEC during this period. Any glitch or unknown inputs are not permitted. Unknown input with standby mode is acceptable.
6. Data retention characteristics are defined later in DATA RETENTION CHARACTERISTICS.

AC TEST CONDITIONS (OVER THE OPERATING RANGE)

Parameter	Symbol	Conditions	Units
Input Rise Time	T_R	1.0	V/ns
Input Fall Time	T_F	1.0	V/ns
Output Timing Reference Level	V_{REF}	$\frac{1}{2} V_{TM}$	V
Output Load Conditions	Refer to Figure 1 and 2		

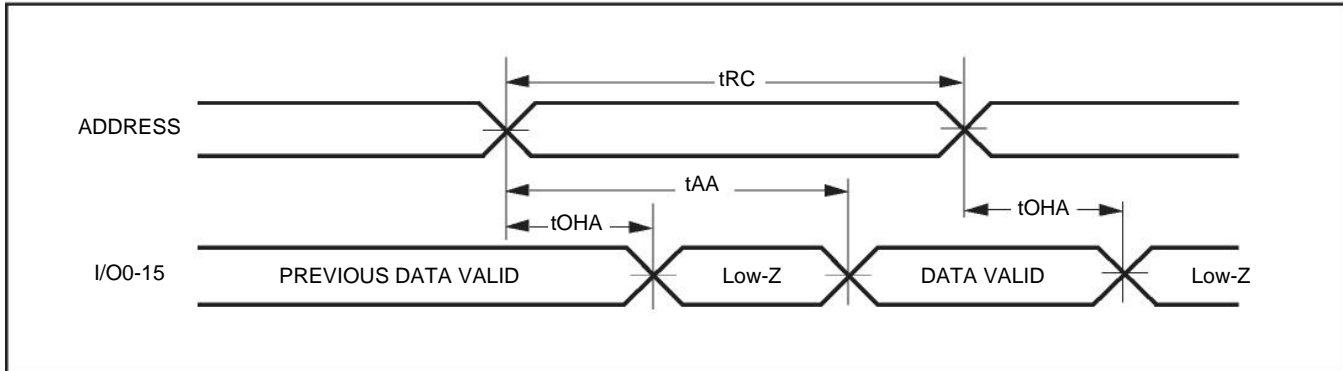
OUTPUT LOAD CONDITIONS FIGURES



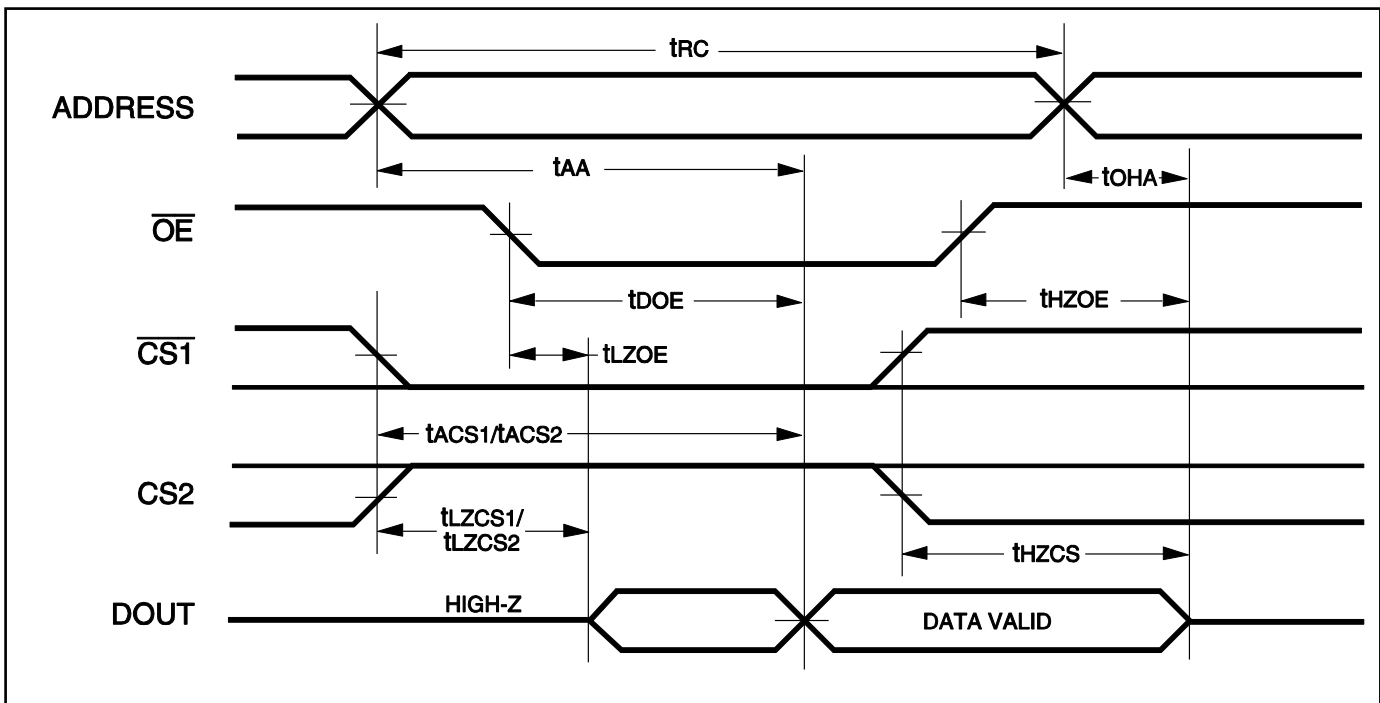
Parameters	$V_{DD}=1.65\sim 1.98V$	$V_{DD}=2.2\sim 2.7V$	$V_{DD}=2.7\sim 3.6V$
R1	13500 Ω	16667 Ω	1103 Ω
R2	10800 Ω	15385 Ω	1554 Ω
V_{TM}	VDD	VDD	VDD

TIMING DIAGRAM

READ CYCLE NO. 1^(1,2) (ADDRESS CONTROLLED) ($\overline{CS1}=\overline{OE}=V_{IL}$, $CS2=\overline{WE}=V_{IH}$)



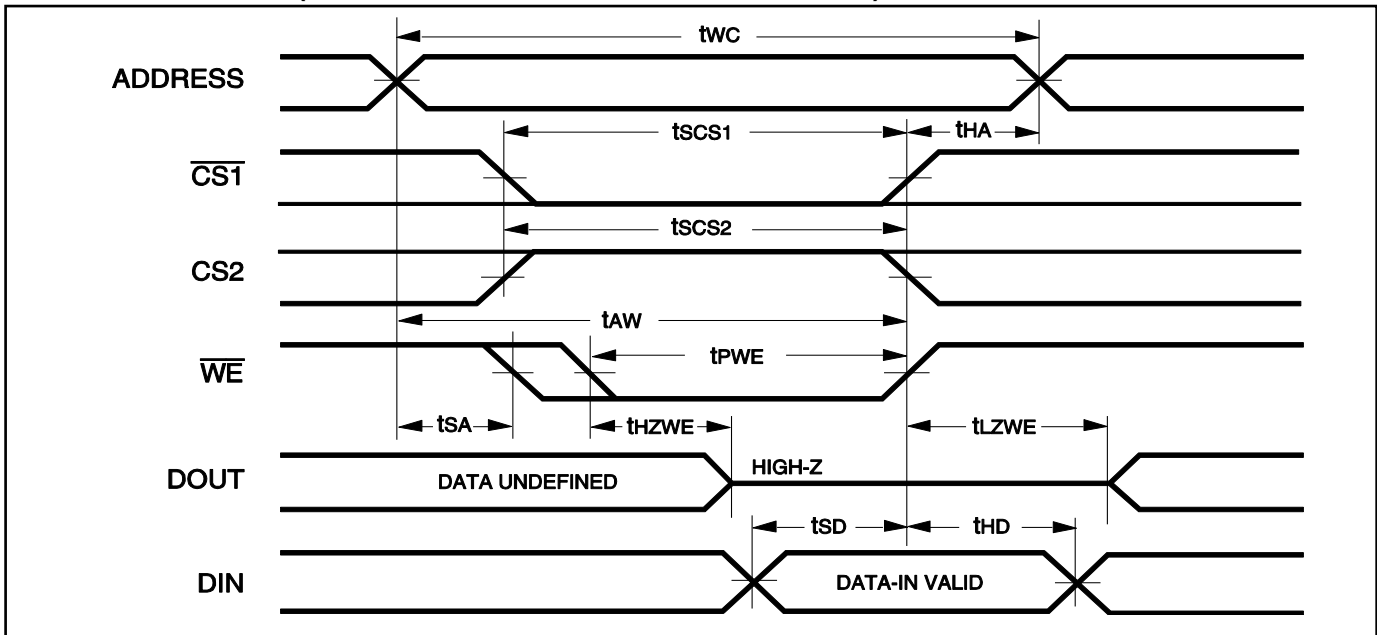
READ CYCLE NO. 2^(1,3) ($\overline{CS1}$, $CS2$, AND \overline{OE} CONTROLLED)



Notes:

1. \overline{WE} is HIGH for a Read Cycle.
2. The device is continuously selected. \overline{OE} , $\overline{CS1}=V_{IL}$. $CS2=\overline{WE}=V_{IH}$.
3. Address is valid prior to or coincident with $\overline{CS1}$ LOW and $CS2$ HIGH transition.

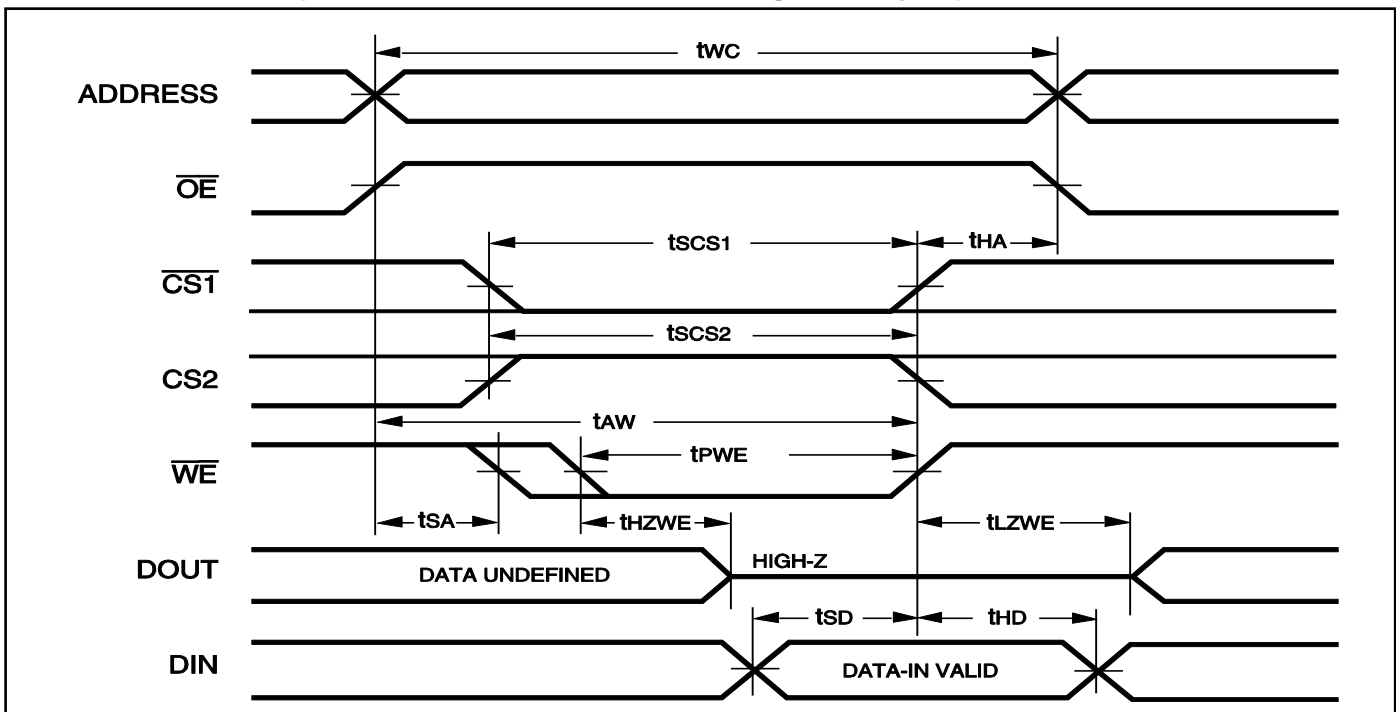
WRITE CYCLE NO. 1 ($\overline{CS1}$ CONTROLLED, \overline{OE} = HIGH OR LOW)



Notes:

1. tHZWE is based on the assumption when tSA=0nS after READ operation. Actual DOUT for tHZWE may not appear if \overline{OE} goes high before Write Cycle. tHZOE is the time DOUT goes to High-Z after \overline{OE} goes high.
2. During this period the I/Os are in output state. Do not apply input signals.

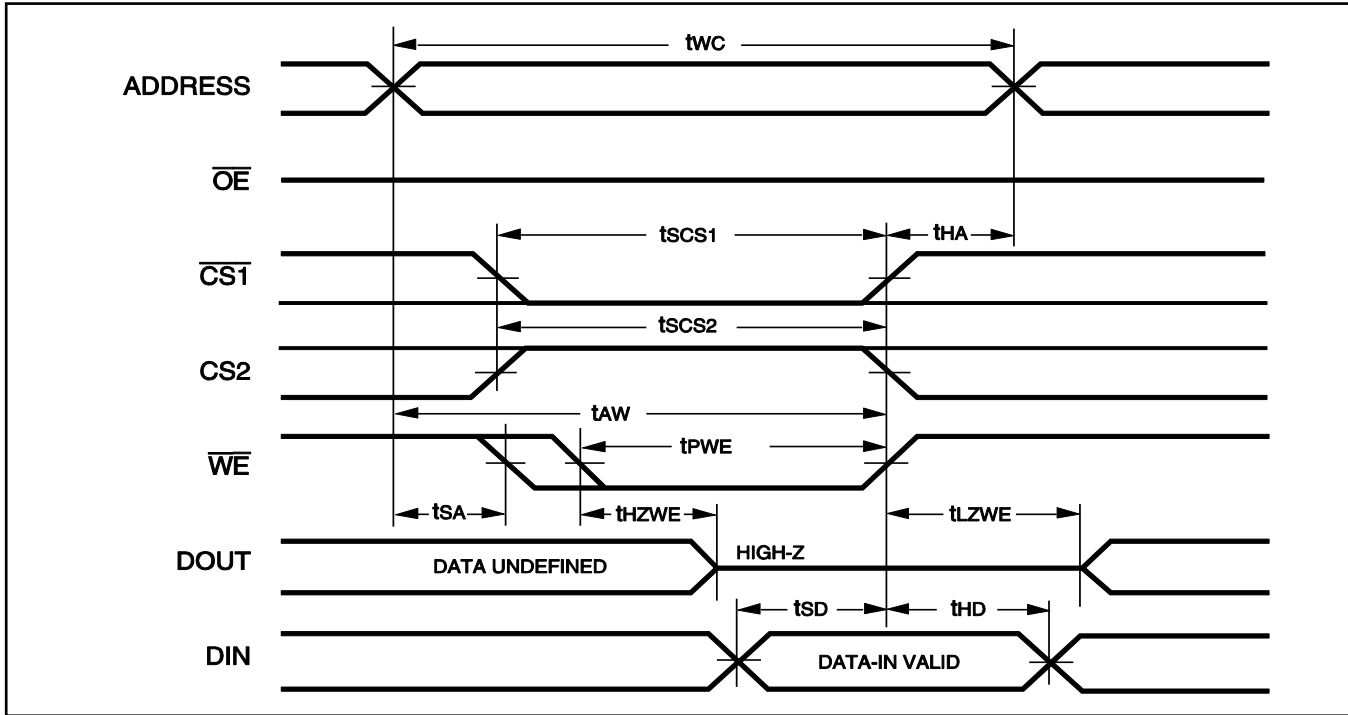
WRITE CYCLE NO. 2 (\overline{WE} Controlled: \overline{OE} is HIGH During Write Cycle)



Notes:

1. tHZWE is based on the assumption when tSA=0nS after READ operation. Actual DOUT for tHZWE may not appear if \overline{OE} goes high before Write Cycle. tHZOE is the time DOUT goes to High-Z after \overline{OE} goes high.
2. During this period the I/Os are in output state. Do not apply input signals.

WRITE CYCLE NO. 3 (\overline{WE} CONTROLLED: \overline{OE} IS LOW DURING WRITE CYCLE)



Notes:

If \overline{OE} is low during write cycle, t_{HZWE} must be met in the application. Do not apply input signal during this period. Data output from the previous READ operation will drive IO BUS.

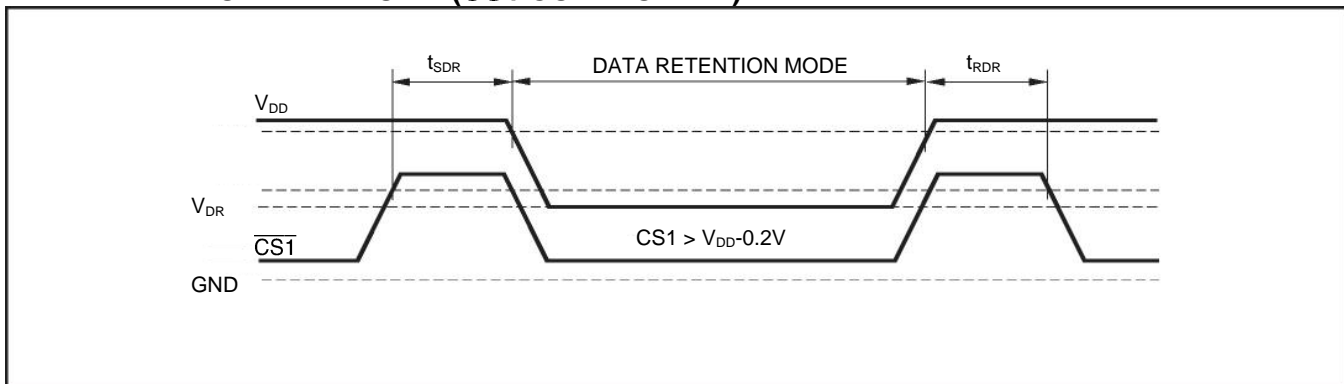
DATA RETENTION CHARACTERISTICS

Symbol	Parameter	Test Condition	OPTION	Min.	Typ. ⁽²⁾	Max.	Unit
V _{DR}	V _{DD} for Data Retention	See Data Retention Waveform	IS62(5)WV20488EALL	1.5		-	V
			IS62(5)WV20488EBLL	1.5		-	V
I _{DR}	Data Retention Current	V _{DD} = V _{DR} (min), (1) 0V ≤ CS2 ≤ 0.2V, or (2) $\overline{CS1} \geq V_{DD} - 0.2V$, CS2 ≥ V _{DD} - 0.2V	Com.	-	-	50	uA
			Ind.	-	-	65	
			Auto	-	-	165	
t _{SDR}	Data Retention Setup Time	See Data Retention Waveform		0	-	-	ns
t _{RDR}	Recovery Time	See Data Retention Waveform		t _{RC}	-	-	ns

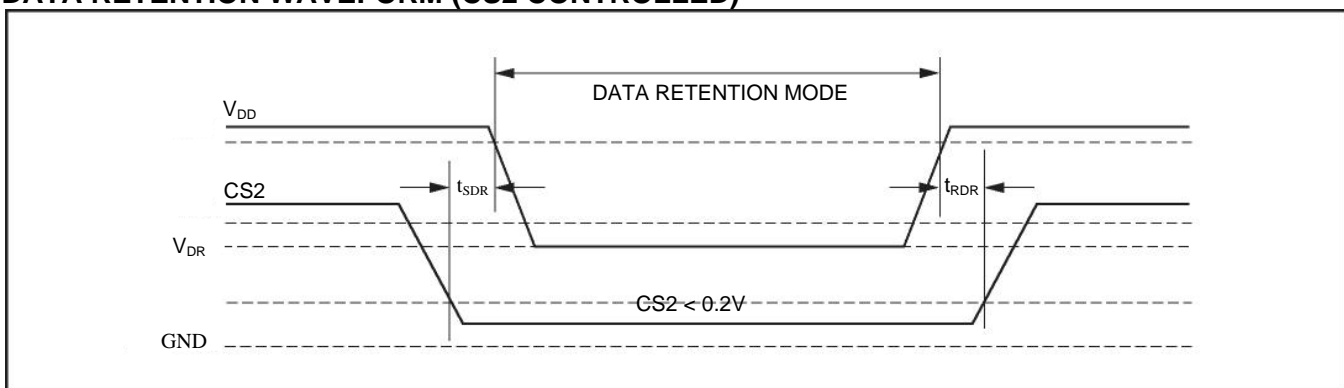
Note:

1. If $\overline{CS1} > V_{DD} - 0.2V$, all other inputs including CS2 must meet this condition.
2. Typical values are measured at V_{DD}=V_{DR}(min), TA = 25°C and not 100% tested.

DATA RETENTION WAVEFORM ($\overline{CS1}$ CONTROLLED)



DATA RETENTION WAVEFORM (CS2 CONTROLLED)



ORDERING INFORMATION: IS62WV20488EALL

1.65V-1.98V Industrial Range (-40°C to +85°C)

Speed (ns)	Order Part No	Package
55	IS62WV20488EALL-55BI	48-pin mini BGA (6mmx8mm)
	IS62WV20488EALL-55BLI	48-pin mini BGA (6mmx8mm), Lead-free

ORDERING INFORMATION: IS62WV20488EBLL

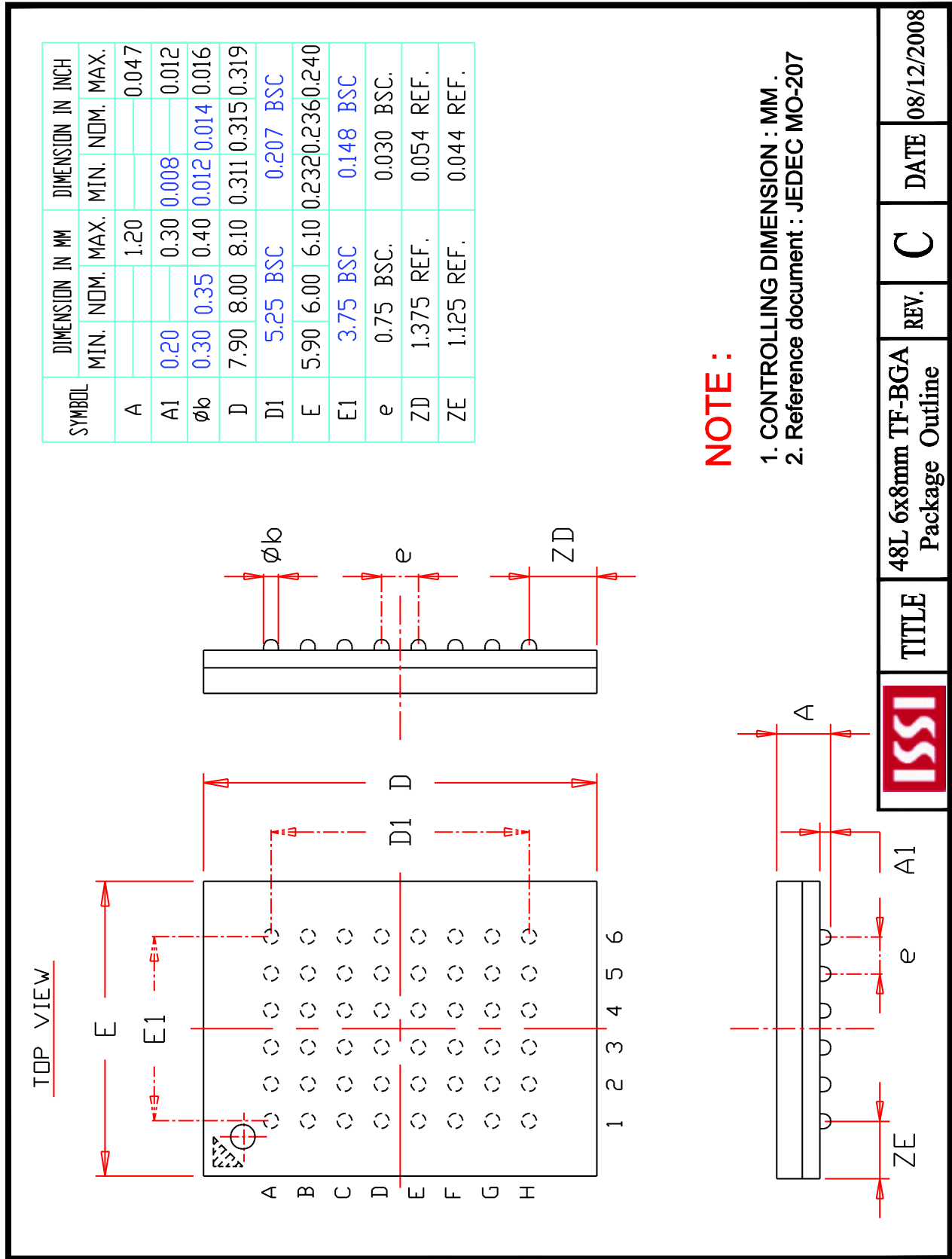
2.2V-3.6V Industrial Range (-40°C to +85°C)

Speed (ns)	Order Part No	Package
45	IS62WV20488EBLL-45BI	48-pin mini BGA (6mmx8mm)
	IS62WV20488EBLL-45BLI	48-pin mini BGA (6mmx8mm), Lead-free
55	IS62WV20488EBLL-55BI	48-pin mini BGA (6mmx8mm)
	IS62WV20488EBLL-55BLI	48-pin mini BGA (6mmx8mm), Lead-free

ORDERING INFORMATION: IS65WV20488EBLL

2.2V-3.6V Automotive Range (-40°C to +125°C)

Speed (ns)	Order Part No	Package
55	IS65WV20488EBLL-55BA3	48-pin mini BGA (6mmx8mm)
	IS65WV20488EBLL-55BLA3	48-pin mini BGA (6mmx8mm), Lead-free



ISSI	TITLE	REV.	DATE
	48L 6x8mm TF-BGA Package Outline	C	08/12/2008

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- При необходимости вся продукция военного и аэрокосмического назначения проходит испытания и сертификацию в лаборатории (по согласованию с заказчиком);
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JONHON

«**JONHON**» (основан в 1970 г.)

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